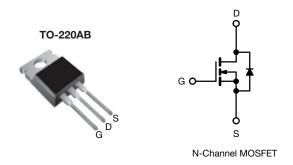
SiHP22N60EF



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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.158				
Q _g max. (nC)	96					
Q _{gs} (nC)	9					
Q _{gd} (nC)	21					
Configuration	Single					

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP22N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL LIMIT		UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage			V _{GS}	± 30		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D -	19		
	V _{GS} at 10 V	T _C = 100 °C		12	А	
Pulsed drain current ^a			I _{DM}	46		
Linear derating factor				1.4	W/°C	
Single pulse avalanche energy ^b			E _{AS}	144	mJ	
Maximum power dissipation			PD	179	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		alı . / alt	70		
Reverse diode dv/dt d	•		dv/dt	50	V/ns	
Soldering recommendations (peak temperature) ^c	Idering recommendations (peak temperature) c For 10 s			260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 3.2 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt = 400$ A/µs, starting $T_J = 25 \ ^\circ C$

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THERMAL RESISTANCE RA	TINGS						
PARAMETER	SYMBOL	TYP.	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-	62		°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-	0.7		-C/W		
SPECIFICATIONS (T _J = 25 °C	unless otherwi	se noted)					
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static	•	·			•	•	

Static							-
Drain-source breakdown voltage	V _{DS}	V _{GS} =	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		0.68	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		2.0	-	4.0	V
Gata source lookage			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μA
7		V _{DS} =	= 480 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	500	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 11 A	-	0.158	0.182	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D = 11 A	-	5.8	-	S
Dynamic					•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$		-	1423	-	
Output capacitance	C _{oss}	1	$V_{\rm DS} = 100 \rm V,$	-	73	-	1
Reverse transfer capacitance	C _{rss}		f = 1 MHz		5	-	pF
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	48	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	240	-	
Total gate charge	Qg			-	48	96	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 11 A, V _{DS} = 480 V	-	9	-	nC
Gate-drain charge	Q _{gd}			-	21	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 11 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	15	30	- ns
Rise time	t _r			-	21	42	
Turn-off delay time	t _{d(off)}			-	58	87	
Fall time	t _f			-	25	50	1
Gate input resistance	R _g	f = 1 MHz, open drain		0.3	0.6	1.2	Ω
Drain-Source Body Diode Characteristic	cs				•		
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	19	
Pulsed diode forward current	I _{SM}	p - n junction diode		-	-	46	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A},$ di/dt = 100 A/µs, V _R = 400 V		-	113	226	ns
Reverse recovery charge	Q _{rr}			-	0.7	1.4	μC
Reverse recovery current	I _{BBM}			_	11	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

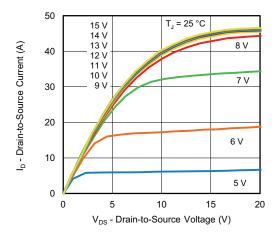


Fig. 1 - Typical Output Characteristics

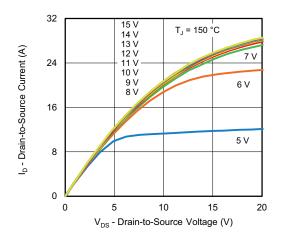


Fig. 2 - Typical Output Characteristics

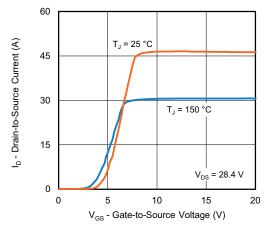


Fig. 3 - Typical Transfer Characteristics

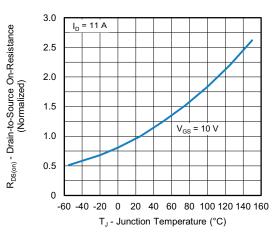


Fig. 4 - Normalized On-Resistance vs. Temperature

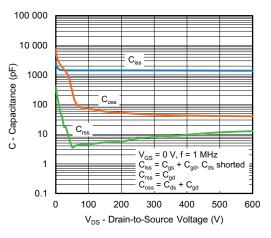


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

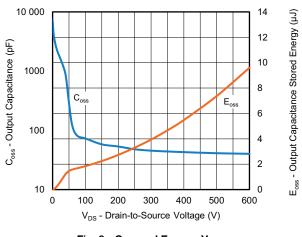


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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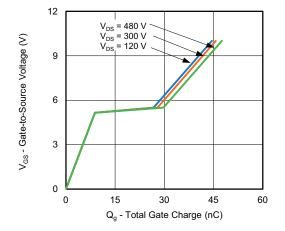


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

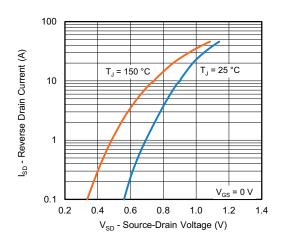
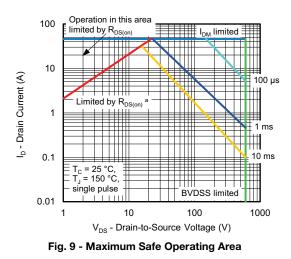
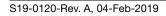


Fig. 8 - Typical Source-Drain Diode Forward Voltage



Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



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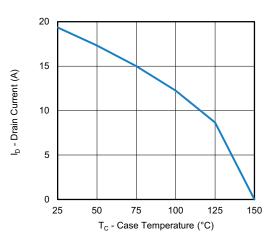


Fig. 10 - Maximum Drain Current vs. Case Temperature

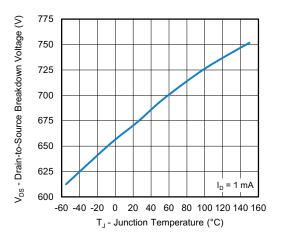


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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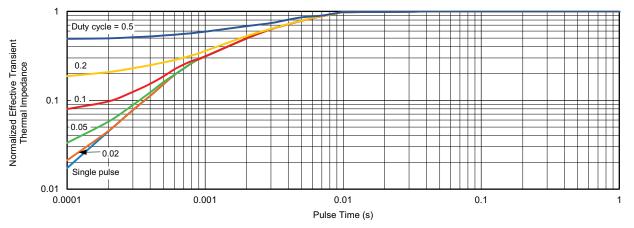


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

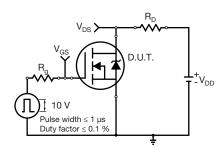


Fig. 13 - Switching Time Test Circuit

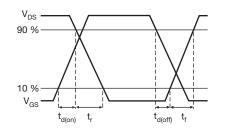


Fig. 14 - Switching Time Waveforms

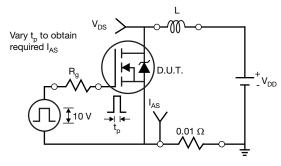


Fig. 15 - Unclamped Inductive Test Circuit

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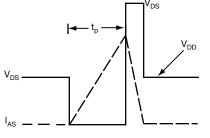


Fig. 16 - Unclamped Inductive Waveforms

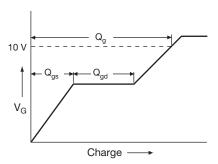
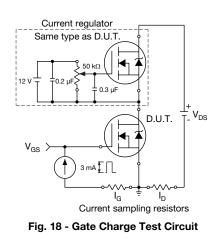
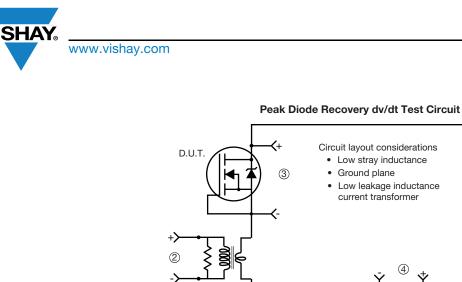


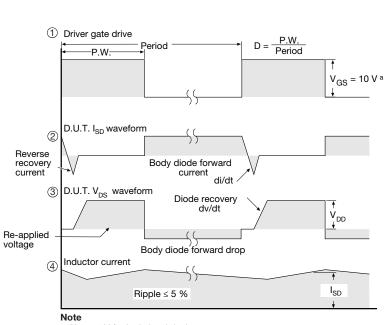
Fig. 17 - Basic Gate Charge Waveform



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dv/dt controlled by R_g
Driver same type as D.U.T.

I_{SD} controlled by duty factor "D"
D.U.T. - device under test

a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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V_{DD}



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